

ADC084S021

4 Channel, 50 ksp/s to 200 Ksp/s, 8-Bit A/D Converter

General Description

The ADC084S021 is a low-power, four-channel CMOS 8-bit analog-to-digital converter with a high-speed serial interface. Unlike the conventional practice of specifying performance at a single sample rate only, the ADC084S021 is fully specified over a sample rate range of 50 ksp/s to 200 ksp/s. The converter is based upon a successive-approximation register architecture with an internal track-and-hold circuit. It can be configured to accept up to four input signals at inputs IN1 through IN4.

The output serial data is straight binary, and is compatible with several standards, such as SPI™, QSPI™, MICROWIRE, and many common DSP serial interfaces.

The ADC084S021 operates with a single supply that can range from +2.7V to +5.25V. Normal power consumption using a +3V or +5V supply is 1.6 mW and 5.8 mW, respectively. The power-down feature reduces the power consumption to just 0.12 μW using a +3V supply, or 0.35 μW using a +5V supply.

The ADC084S021 is packaged in a 10-lead MSOP package. Operation over the industrial temperature range of -40°C to +85°C is guaranteed.

Features

- Specified over a range of sample rates.
- Four input channels
- Variable power management
- Single power supply with 2.7V - 5.25V range

Key Specifications

- DNL ±0.04 LSB (typ)
- INL ±0.04 LSB (typ)
- SNR 49.6 dB (typ)
- Power Consumption
 - 3V Supply 1.6 mW (typ)
 - 5V Supply 5.8 mW (typ)

Applications

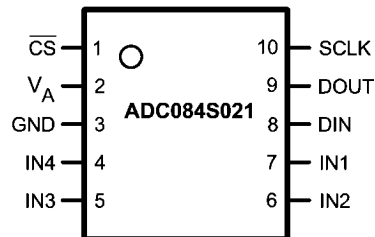
- Portable Systems
- Remote Data Acquisition
- Instrumentation and Control Systems

Pin-Compatible Alternatives by Resolution and Speed

All devices are fully pin and function compatible.

Resolution	Specified for Sample Rate Range of:		
	50 to 200 ksp/s	200 to 500 ksp/s	500 ksp/s to 1 Msps
12-bit	ADC124S021	ADC124S051	ADC124S101
10-bit	ADC104S021	ADC104S051	ADC104S101
8-bit	ADC084S021	ADC084S051	ADC084S101

Connection Diagram

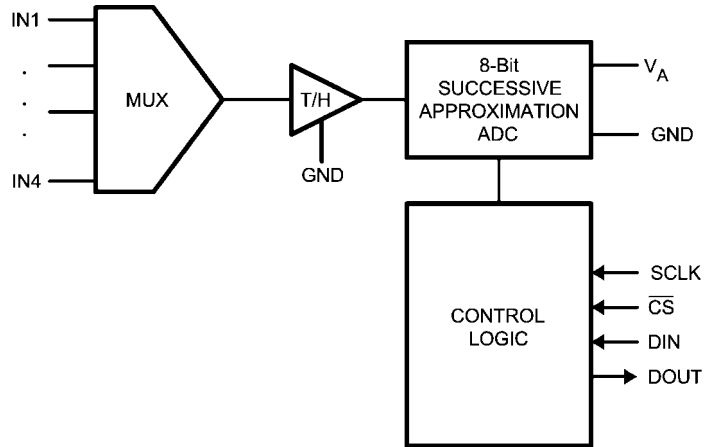


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Ordering Information

Order Code	Temperature Range	Description	Top Mark
ADC084S021C1MM	-40°C to +85°C	10-Lead MSOP Package	X19C
ADC084S021C1MMX	-40°C to +85°C	10-Lead MSOP Package, Tape & Reel	X19C
ADC084S021EVAL		Evaluation Board	

Block Diagram



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Pin Descriptions and Equivalent Circuits

Pin No.	Symbol	Description
ANALOG I/O		
4-7	IN1 to IN4	Analog inputs. These signals can range from 0V to V_A .
DIGITAL I/O		
10	SCLK	Digital clock input. This clock directly controls the conversion and readout processes.
9	DOUT	Digital data output. The output samples are clocked out at this pin on falling edges of the SCLK pin.
8	DIN	Digital data input. The ADC084S021's Control Register is loaded through this pin on rising edges of SCLK.
1	\overline{CS}	Chip select. A conversion begins at the falling edge of \overline{CS} . Conversions continue as long as \overline{CS} is held low.
POWER SUPPLY		
2	V_A	Positive supply pin. This pin should be connected to a quiet +2.7V to +5.25V source and be bypassed to GND with a 0.1 μ F monolithic capacitor located within 1 cm of the power pin and with a 1 μ F capacitor.
3	GND	Device ground return for all signals.

Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage V_A	-0.3V to 6.5V
Voltage on Any Pin to GND	-0.3V to V_A +0.3V
Input Current at Any Pin (Note 3)	± 10 mA
Package Input Current (Note 3)	± 20 mA
Power Consumption at $T_A = 25^\circ\text{C}$	See (Note 4)
ESD Susceptibility (Note 5)	
Human Body Model	2500V
Machine Model	250V
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C

Operating Ratings (Notes 1, 2)

Operating Temperature Range	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
V_A Supply Voltage	+2.7V to +5.25V
Digital Input Pins Voltage Range	-0.3V to V_A
Clock Frequency	0.8 MHz to 3.2 MHz
Analog Input Voltage	0V to V_A

Package Thermal Resistance

Package	θ_{JA}
10-lead MSOP	190°C / W

Soldering process must comply with National Semiconductor's Reflow Temperature Profile specifications. Refer to www.national.com/packaging. (Note 6)

ADC084S021 Converter Electrical Characteristics (Note 9)

The following specifications apply for $V_A = +2.7\text{V}$ to 5.25V, GND = 0V, $f_{\text{SCLK}} = 0.8$ MHz to 3.2 MHz, $f_{\text{SAMPLE}} = 50$ ksp/s to 200 ksp/s, $C_L = 50$ pF, unless otherwise noted. **Boldface limits apply for $T_A = T_{\text{MIN}}$ to T_{MAX}** ; all other limits $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	Typical	Limits (Note 7)	Units
STATIC CONVERTER CHARACTERISTICS					
	Resolution with No Missing Codes			8	Bits
INL	Integral Non-Linearity		± 0.04	± 0.2	LSB (max)
DNL	Differential Non-Linearity		± 0.04	± 0.2	LSB (max)
V_{OFF}	Offset Error		+0.52	± 0.7	LSB (max)
OEM	Channel to Channel Offset Error Match		± 0.01	± 0.3	LSB (max)
FSE	Full-Scale Error		+0.51	± 0.7	LSB (max)
FSEM	Channel to Channel Full-Scale Error Match		+0.01	± 0.3	LSB (max)
DYNAMIC CONVERTER CHARACTERISTICS					
SINAD	Signal-to-Noise Plus Distortion Ratio	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 39.9$ kHz, -0.02 dBFS	49.6	49.1	dB (min)
SNR	Signal-to-Noise Ratio	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 39.9$ kHz, -0.02 dBFS	49.6	49.2	dB (min)
THD	Total Harmonic Distortion	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 39.9$ kHz, -0.02 dBFS	-76	-62	dB (max)
SFDR	Spurious-Free Dynamic Range	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 39.9$ kHz, -0.02 dBFS	68	63	dB (min)
ENOB	Effective Number of Bits	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 39.9$ kHz, -0.02 dBFS	7.9	7.9	Bits (min)
	Channel-to-Channel Crosstalk	$V_A = +5.25\text{V}$ $f_{\text{IN}} = 39.9$ kHz	-73		dB
IMD	Intermodulation Distortion, Second Order Terms	$V_A = +5.25\text{V}$ $f_a = 40.161$ kHz, $f_b = 41.015$ kHz	-78		dB
	Intermodulation Distortion, Third Order Terms	$V_A = +5.25\text{V}$ $f_a = 40.161$ kHz, $f_b = 41.015$ kHz	-73		dB
FPBW	-3 dB Full Power Bandwidth	$V_A = +5\text{V}$	11		MHz
		$V_A = +3\text{V}$	8		MHz

Symbol	Parameter	Conditions	Typical	Limits (Note 7)	Units
ANALOG INPUT CHARACTERISTICS					
V_{IN}	Input Range		0 to V_A		V
I_{DCL}	DC Leakage Current			± 1	μA (max)
C_{INA}	Input Capacitance	Track Mode	33		pF
		Hold Mode	3		pF
DIGITAL INPUT CHARACTERISTICS					
V_{IH}	Input High Voltage	$V_A = +5.25V$		2.4	V (min)
		$V_A = +3.6V$		2.1	V (min)
V_{IL}	Input Low Voltage			0.8	V (max)
I_{IN}	Input Current	$V_{IN} = 0V$ or V_A		± 10	μA (max)
C_{IND}	Digital Input Capacitance		2	4	pF (max)
DIGITAL OUTPUT CHARACTERISTICS					
V_{OH}	Output High Voltage	$I_{SOURCE} = 200 \mu A$	$V_A - 0.03$	$V_A - 0.5$	V (min)
		$I_{SOURCE} = 1 mA$	$V_A - 0.1$		V
V_{OL}	Output Low Voltage	$I_{SINK} = 200 \mu A$	0.03	0.4	V (max)
		$I_{SINK} = 1 mA$	0.1		V
I_{OZH}, I_{OZL}	TRI-STATE® Leakage Current			± 1	μA (max)
C_{OUT}	TRI-STATE® Output Capacitance		2	4	pF (max)
	Output Coding		Straight (Natural) Binary		
POWER SUPPLY CHARACTERISTICS ($C_L = 10 pF$)					
V_A	Supply Voltage			2.7	V (min)
				5.25	V (max)
I_A	Supply Current, Normal Mode (Operational, \overline{CS} low)	$V_A = +5.25V$, $f_{SAMPLE} = 200 \text{ ksps}$, $f_{IN} = 40 \text{ kHz}$	1.1	1.7	mA (max)
		$V_A = +3.6V$, $f_{SAMPLE} = 200 \text{ ksps}$, $f_{IN} = 40 \text{ kHz}$	0.45	0.8	mA (max)
	Supply Current, Shutdown (\overline{CS} high)	$V_A = +5.25V$, $f_{SAMPLE} = 0 \text{ ksps}$	200		nA
		$V_A = +3.6V$, $f_{SAMPLE} = 0 \text{ ksps}$	200		nA
P_D	Power Consumption, Normal Mode (Operational, \overline{CS} low)	$V_A = +5.25V$	5.8	8.9	mW (max)
		$V_A = +3.6V$	1.6	2.9	mW (max)
	Power Consumption, Shutdown (\overline{CS} high)	$V_A = +5.25V$	1.05		μW
		$V_A = +3.6V$	0.72		μW
AC ELECTRICAL CHARACTERISTICS					
f_{SCLK}	Clock Frequency	(Note 8)		0.8	MHz (min)
				3.2	MHz (max)
f_S	Sample Rate	(Note 8)		50	ksps (min)
				200	ksps (max)
t_{CONV}	Conversion Time			13	SCLK cycles
DC	SCLK Duty Cycle	$f_{SCLK} = 3.2 \text{ MHz}$	50	30	% (min)
				70	% (max)
t_{ACQ}	Track/Hold Acquisition Time	Full-Scale Step Input		3	SCLK cycles
	Throughput Time	Acquisition Time + Conversion Time		16	SCLK cycles

ADC084S021 Timing Specifications

The following specifications apply for $V_A = +2.7V$ to $5.25V$, $GND = 0V$, $f_{SCLK} = 0.8$ MHz to 3.2 MHz, $f_{SAMPLE} = 50$ kpsps to 200 kpsps, $C_L = 50$ pF, **Boldface limits apply for $T_A = T_{MIN}$ to T_{MAX}** ; all other limits $T_A = 25^\circ C$.

Symbol	Parameter	Conditions	Typical	Limits (Note 7)	Units	
t_{CSU}	Setup Time SCLK High to \overline{CS} Falling Edge	(Note 10)		10	$V_A = +3.0V$	
			$V_A = +5.0V$	-0.5		
t_{CLH}	Hold time SCLK Low to \overline{CS} Falling Edge	(Note 10)	$V_A = +3.0V$	+4.5	10	ns (min)
			$V_A = +5.0V$	+1.5		
t_{EN}	Delay from \overline{CS} Until DOUT active		$V_A = +3.0V$	+4	30	ns (max)
			$V_A = +5.0V$	+2		
t_{ACC}	Data Access Time after SCLK Falling Edge		$V_A = +3.0V$	+16.5	30	ns (max)
			$V_A = +5.0V$	+15		
t_{SU}	Data Setup Time Prior to SCLK Rising Edge			+3	10	ns (min)
t_H	Data Valid SCLK Hold Time			+3	10	ns (min)
t_{CH}	SCLK High Pulse Width			$0.5 \times t_{SCLK}$	$0.3 \times t_{SCLK}$	ns (min)
t_{CL}	SCLK Low Pulse Width			$0.5 \times t_{SCLK}$	$0.3 \times t_{SCLK}$	ns (min)
t_{DIS}	\overline{CS} Rising Edge to DOUT High-Impedance	Output Falling	$V_A = +3.0V$	1.7	20	ns (max)
			$V_A = +5.0V$	1.2		
		Output Rising	$V_A = +3.0V$	1.0		
			$V_A = +5.0V$	1.0		

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: All voltages are measured with respect to $GND = 0V$, unless otherwise specified.

Note 3: When the input voltage at any pin exceeds the power supply (that is, $V_{IN} < GND$ or $V_{IN} > V_A$), the current at that pin should be limited to 10 mA. The 20 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to two. The Absolute Maximum Rating specification does not apply to the V_A pin. The current into the V_A pin is limited by the Analog Supply Voltage specification.

Note 4: The absolute maximum junction temperature ($T_{J,max}$) for this device is $150^\circ C$. The maximum allowable power dissipation is dictated by $T_{J,max}$, the junction-to-ambient thermal resistance (θ_{JA}), and the ambient temperature (T_A), and can be calculated using the formula $P_{D,MAX} = (T_{J,max} - T_A)/\theta_{JA}$. The values for maximum power dissipation listed above will be reached only when the device is operated in a severe fault condition (e.g. when input or output pins are driven beyond the power supply voltages, or the power supply polarity is reversed). Obviously, such conditions should always be avoided.

Note 5: Human body model is 100 pF capacitor discharged through a 1.5 k Ω resistor. Machine model is 220 pF discharged through zero ohms.

Note 6: Reflow temperature profiles are different for lead-free and non-lead-free packages.

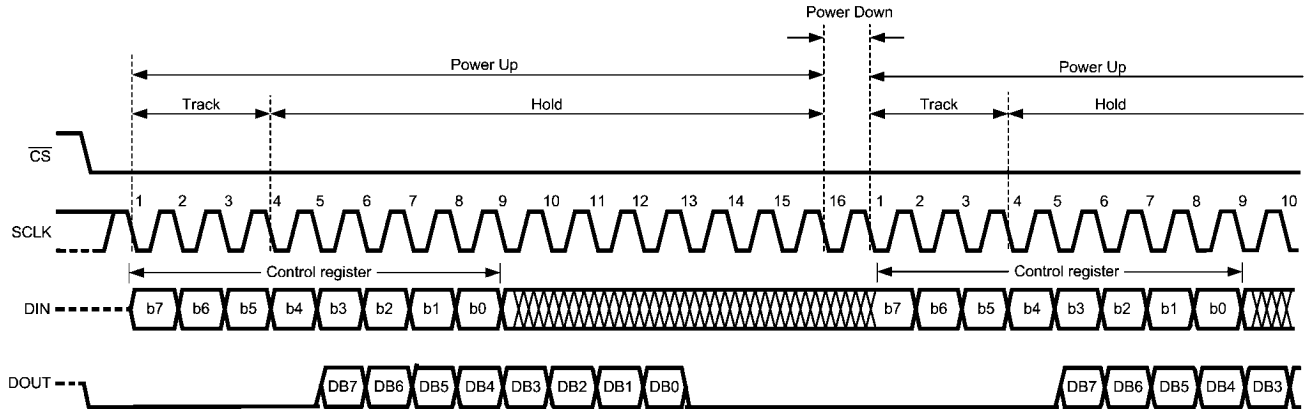
Note 7: Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 8: This is the frequency range over which the electrical performance is guaranteed. The device is functional over a wider range which is specified under Operating Ratings.

Note 9: Min/max specification limits are guaranteed by design, test, or statistical analysis.

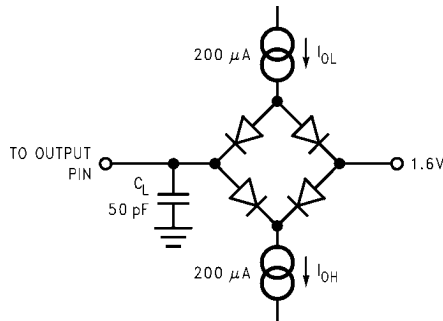
Note 10: Clock may be either high or low when \overline{CS} is asserted as long as setup and hold times t_{CSU} and t_{CLH} are strictly observed.

Timing Diagrams



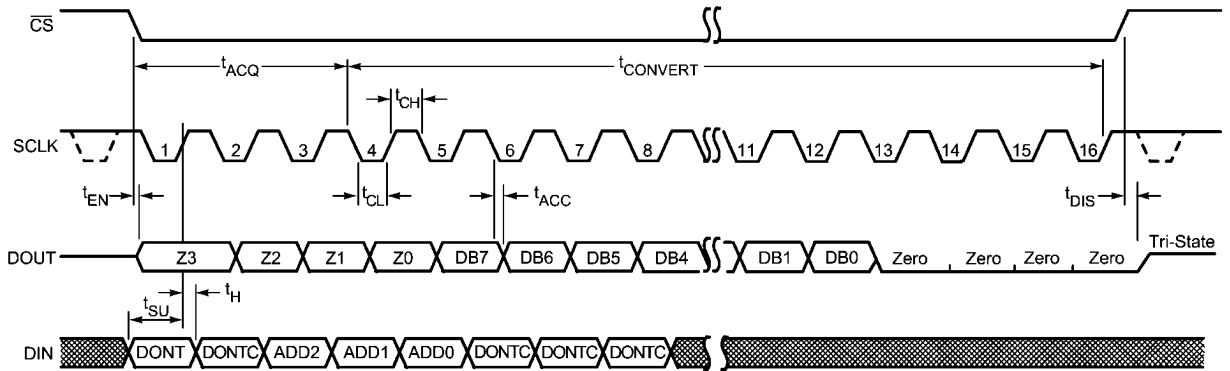
ADC084S021 Operational Timing Diagram

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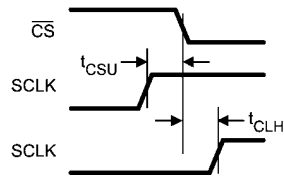
Timing Test Circuit

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ADC084S021 Serial Timing Diagram

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SCLK and CS Timing Parameters

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Specification Definitions

ACQUISITION TIME is the time required to acquire the input voltage. That is, it is time required for the hold capacitor to charge up to the input voltage.

APERTURE DELAY is the time between the fourth falling SCLK edge of a conversion and the time when the input signal is acquired or held for conversion.

CONVERSION TIME is the time required, after the input voltage is acquired, for the ADC to convert the input voltage to a digital word.

CROSSTALK is the coupling of energy from one channel into the other channel, or the amount of signal energy from one analog input that appears at the measured analog input.

DIFFERENTIAL NON-LINEARITY (DNL) is the measure of the maximum deviation from the ideal step size of 1 LSB.

DUTY CYCLE is the ratio of the time that a repetitive digital waveform is high to the total time of one period. The specification here refers to the SCLK.

EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS) is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as $(\text{SINAD} - 1.76) / 6.02$ and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.

FULL POWER BANDWIDTH is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.

FULL SCALE ERROR (FSE) is a measure of how far the last code transition is from the ideal $1\frac{1}{2}$ LSB below V_{REF} , and is defined as:

$$V_{\text{FSE}} = V_{\text{max}} + 1.5 \text{ LSB} - V_{\text{REF}}$$

where V_{max} is the voltage at which the transition to the maximum code occurs. FSE can be expressed in Volts, LSB or percent of full scale range.

GAIN ERROR is the deviation of the last code transition (111...110) to (111...111) from the ideal ($V_{\text{REF}} - 1.5 \text{ LSB}$), after adjusting for offset error.

INTEGRAL NON-LINEARITY (INL) is a measure of the deviation of each individual code from a line drawn from negative full scale ($\frac{1}{2}$ LSB below the first code transition) through positive full scale ($\frac{1}{2}$ LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value.

INTERMODULATION DISTORTION (IMD) is the creation of additional spectral components as a result of two sinusoidal frequencies being applied to the ADC input at the same time. It is defined as the ratio of the power in the second and third order intermodulation products to the sum of the power in both of the original frequencies. IMD is usually expressed in dB.

MISSING CODES are those output codes that will never appear at the ADC outputs. These codes cannot be reached with any input value. The ADC084S021 is guaranteed not to have any missing codes.

OFFSET ERROR is the deviation of the first code transition (000...000) to (000...001) from the ideal (i.e. $\text{GND} + 0.5 \text{ LSB}$).

SIGNAL TO NOISE RATIO (SNR) is the ratio, expressed in dB, of the rms value of the input signal at the converter output to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including d.c. or harmonics included in the THD specification.

SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD) Is the ratio, expressed in dB, of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding d.c.

SPURIOUS FREE DYNAMIC RANGE (SFDR) is the difference, expressed in dB, between the rms values of the input signal and the peak spurious signal where a spurious signal is any signal present in the output spectrum that is not present at the input, excluding d.c.

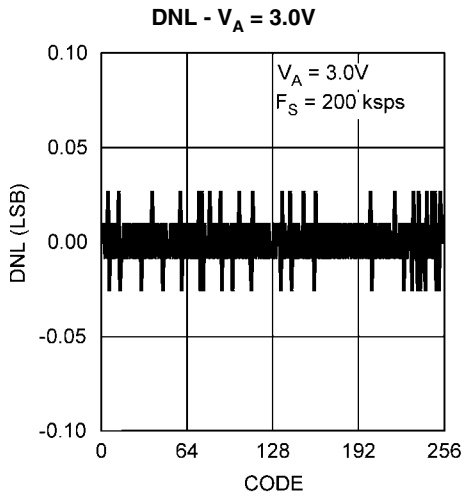
TOTAL HARMONIC DISTORTION (THD) is the ratio, expressed in dB or dBc, of the rms total of the first five harmonic components at the output to the rms level of the input signal frequency as seen at the output. THD is calculated as

$$\text{THD} = 20 \cdot \log_{10} \sqrt{\frac{A_{f_2}^2 + \dots + A_{f_6}^2}{A_{f_1}^2}}$$

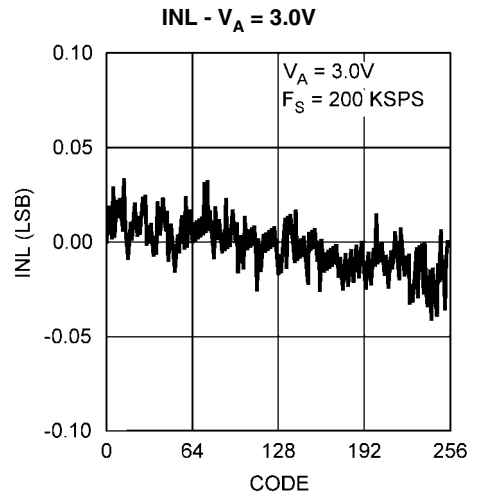
where A_{f_1} is the RMS power of the input frequency at the output and A_{f_2} through A_{f_6} are the RMS power in the first 5 harmonic frequencies.

THROUGHPUT TIME is the minimum time required between the start of two successive conversion. It is the acquisition time plus the conversion and read out times. In the case of the ADC084S021, this is 16 SCLK periods.

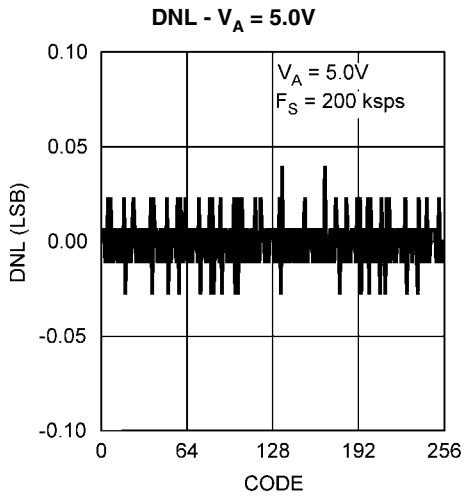
Typical Performance Characteristics $T_A = +25^\circ\text{C}$, $f_{\text{SAMPLE}} = 50 \text{ kpsps to } 200 \text{ kpsps}$,
 $f_{\text{SCLK}} = 0.8 \text{ MHz to } 3.2 \text{ MHz}$, $f_{\text{IN}} = 39.9 \text{ kHz}$ unless otherwise stated.



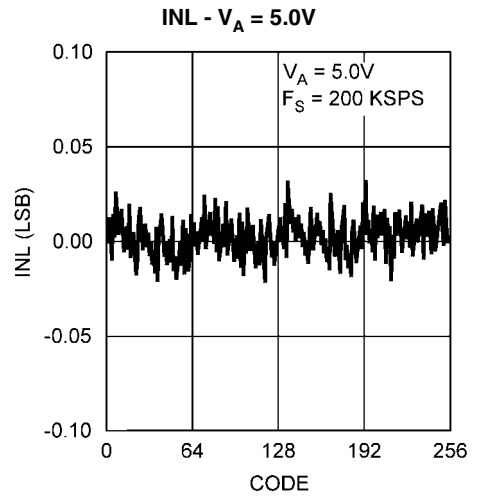
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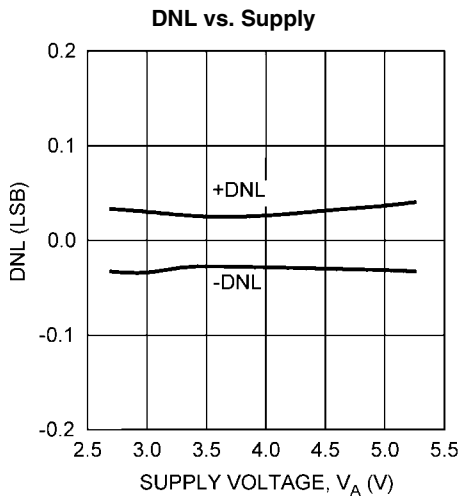
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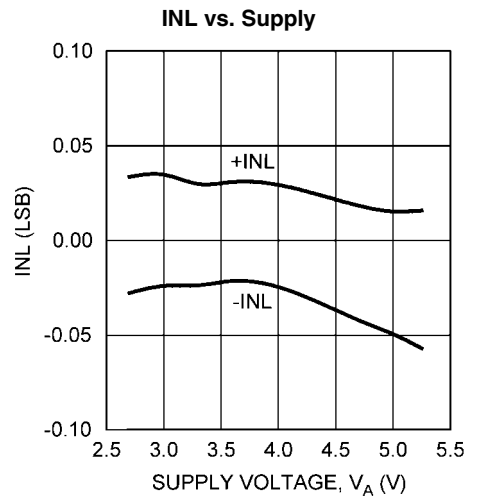
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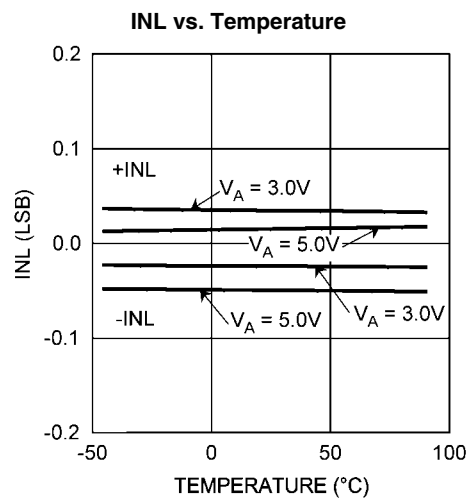
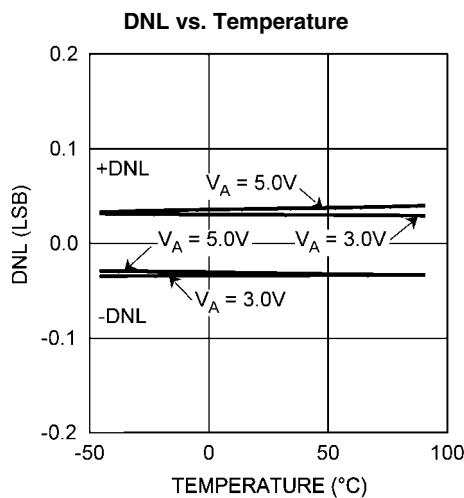
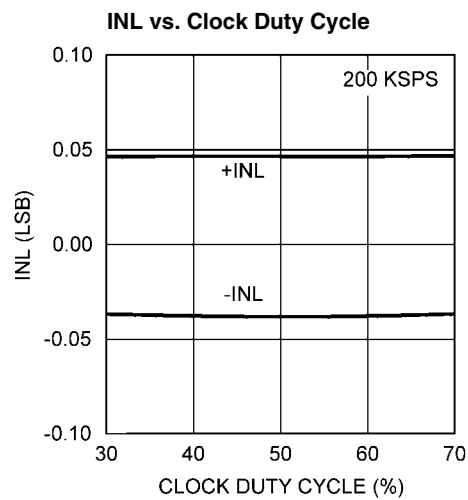
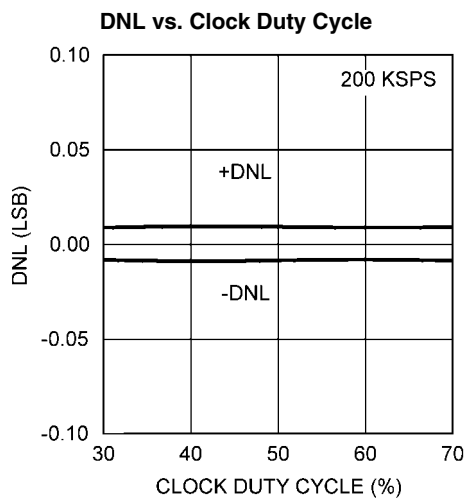
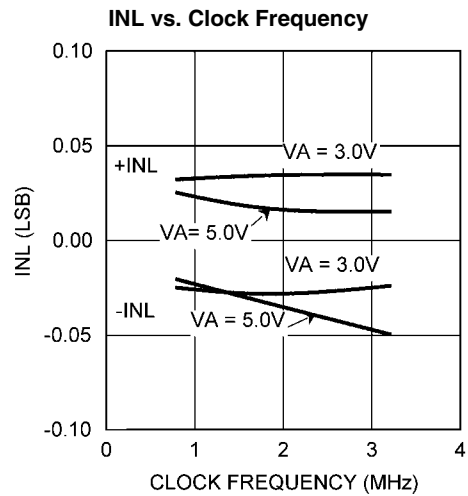
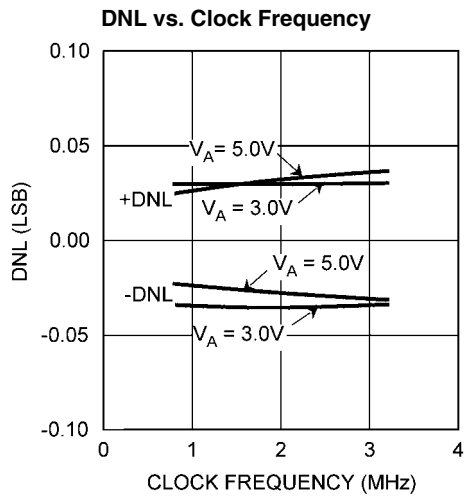
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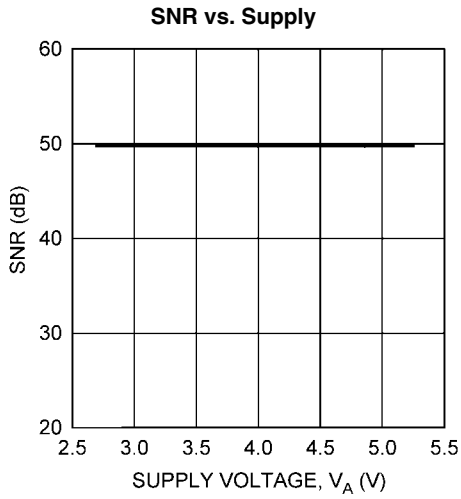


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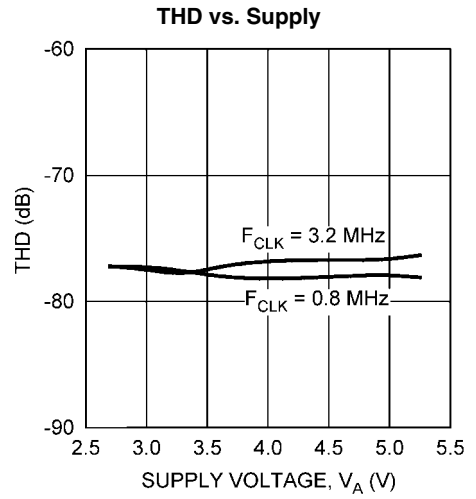


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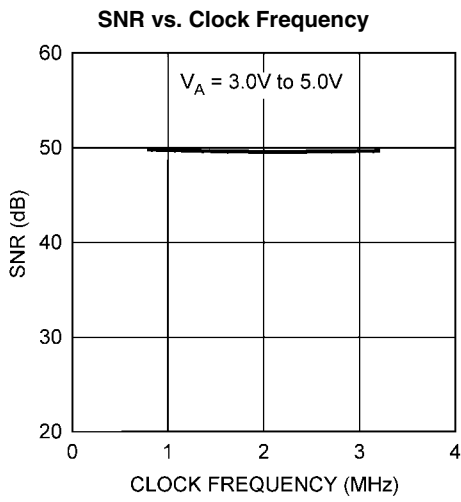




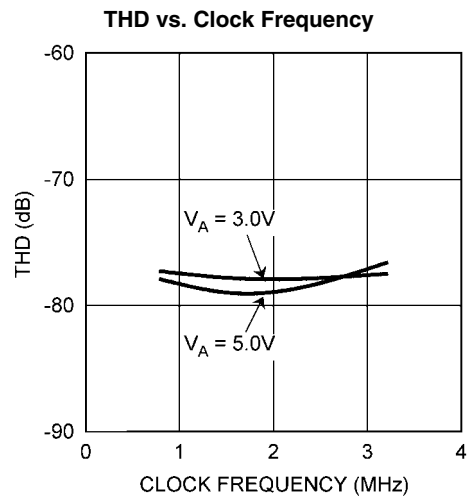
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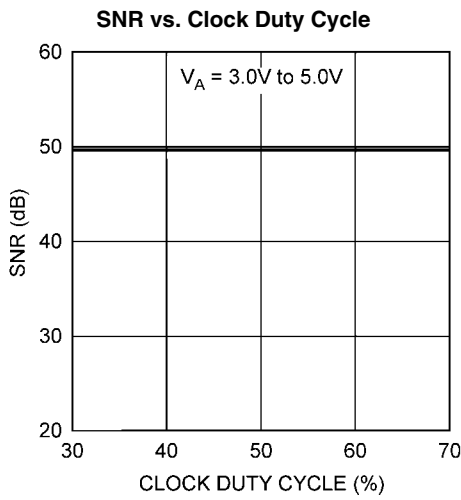
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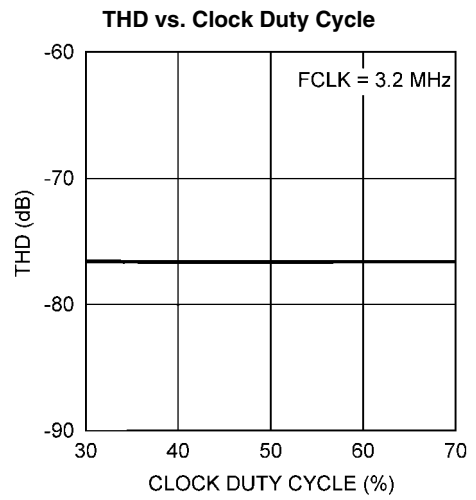
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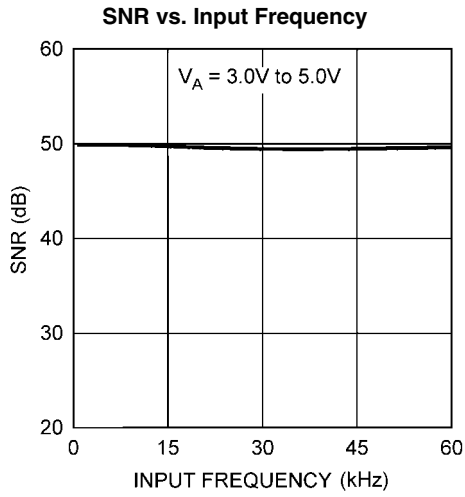
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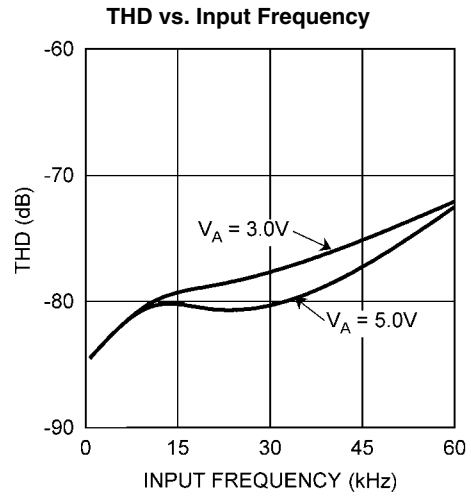
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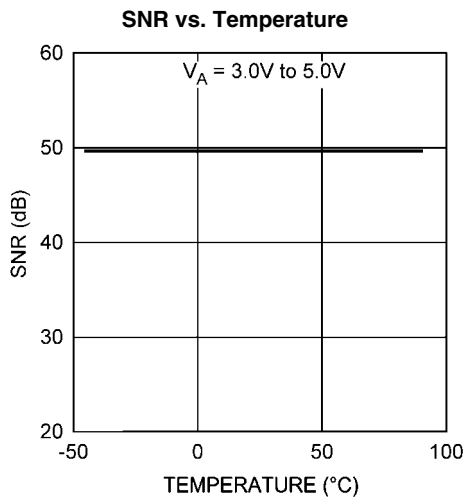
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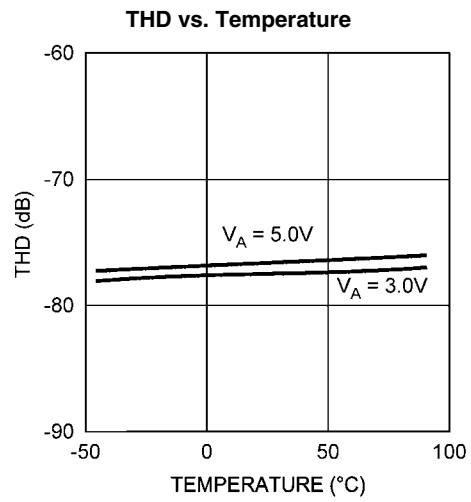
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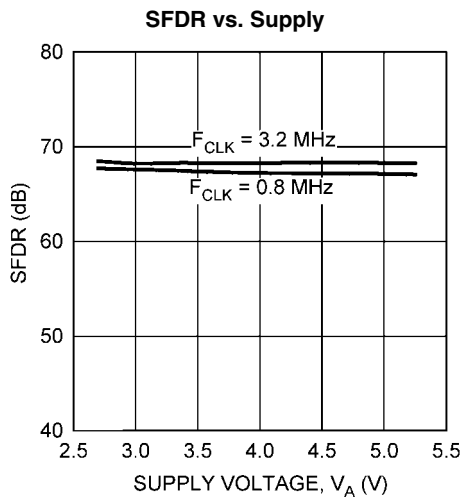
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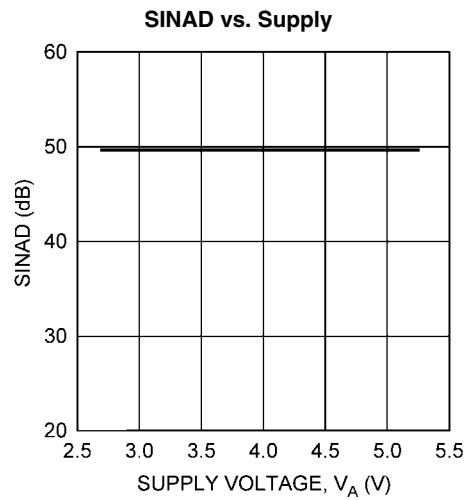
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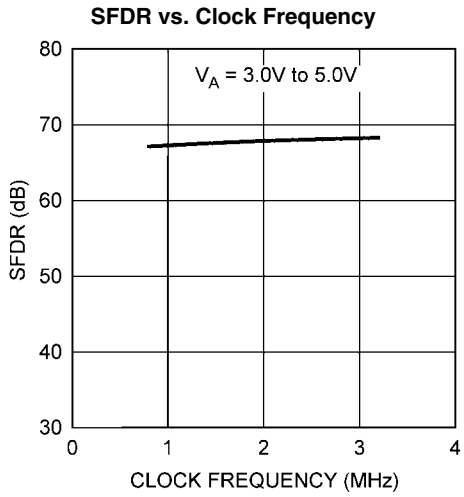
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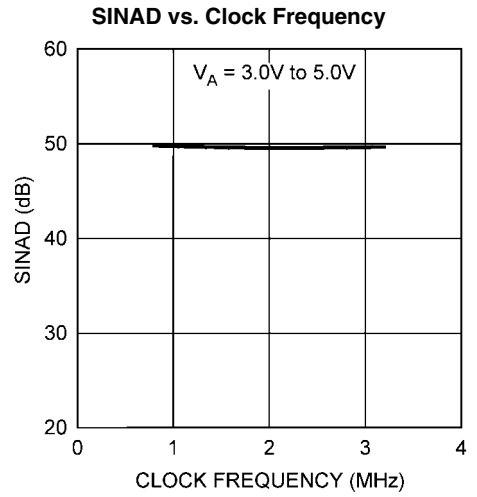
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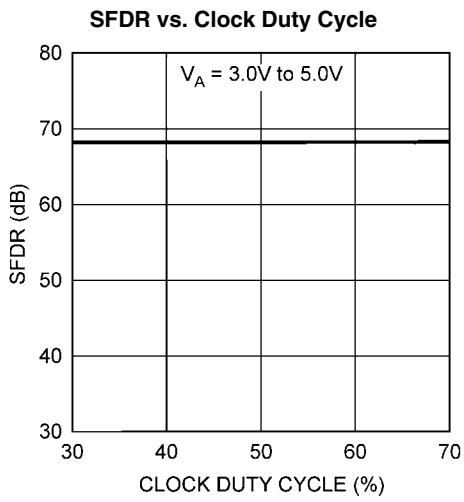
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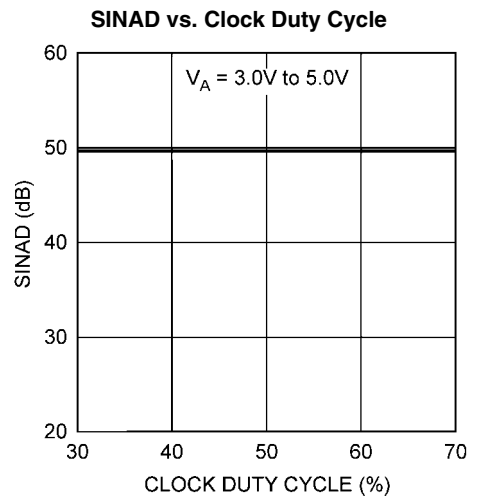
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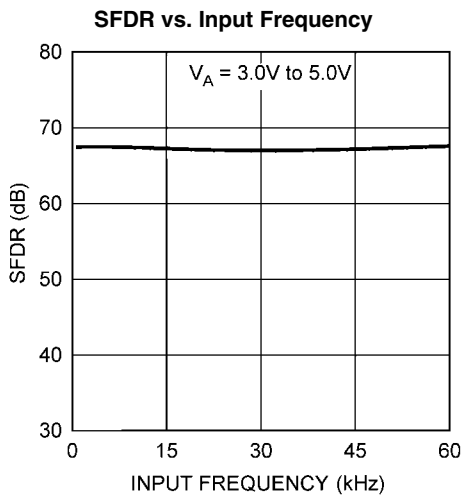
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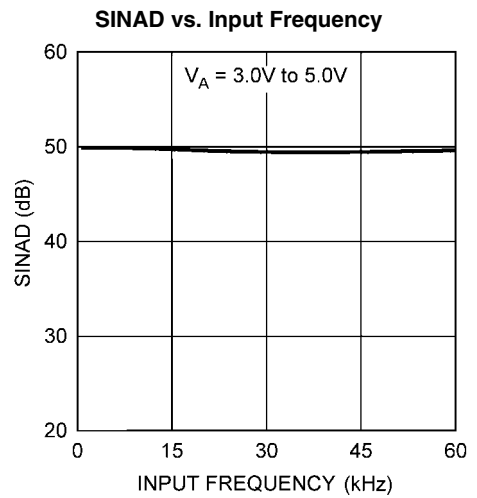
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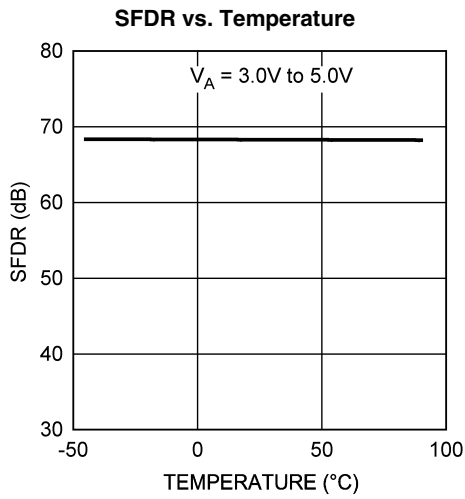
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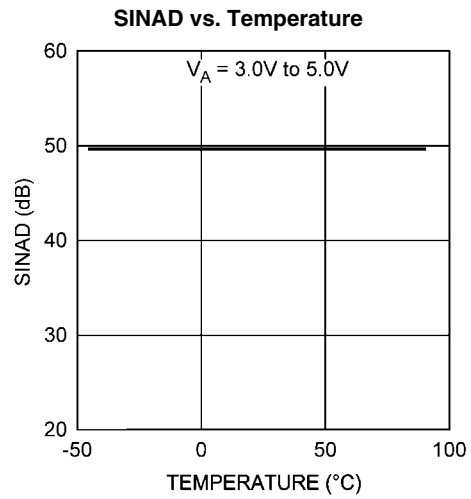
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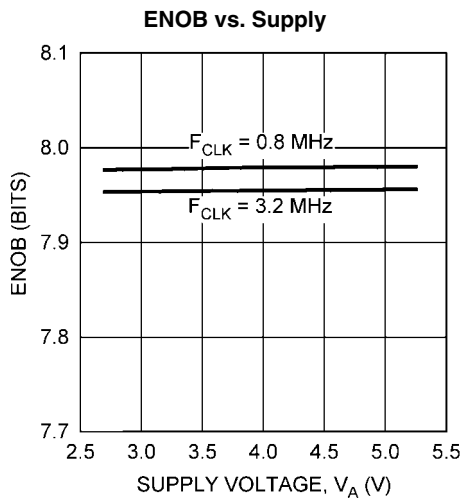
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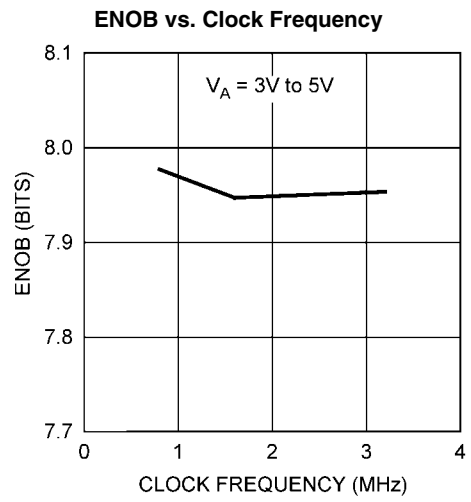
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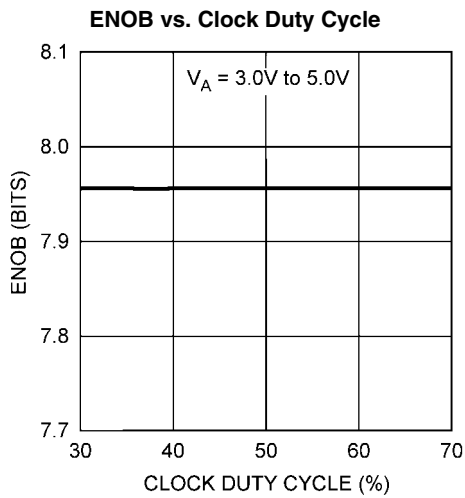
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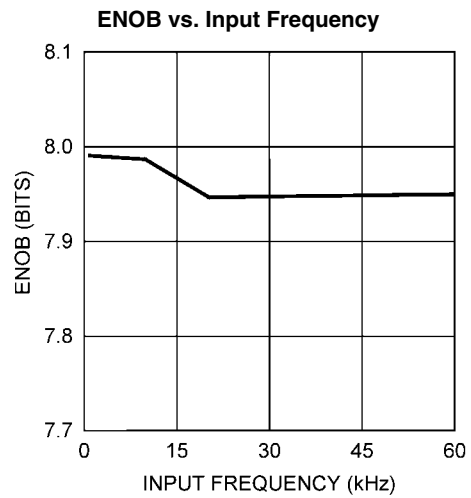
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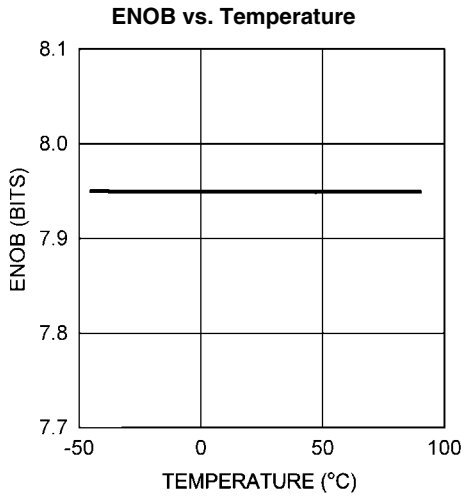
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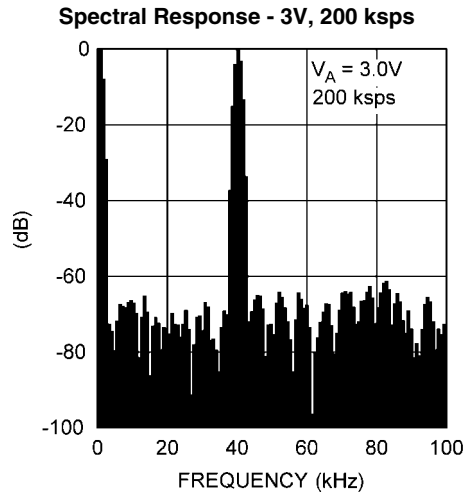
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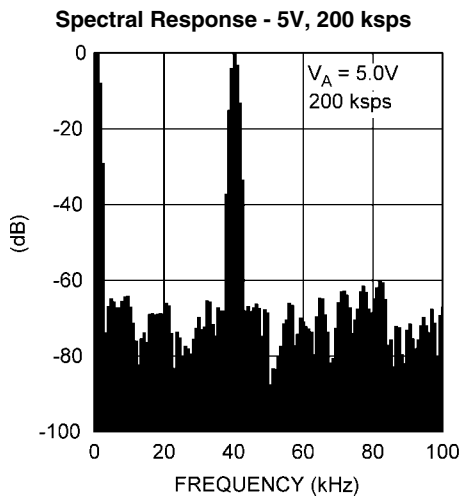
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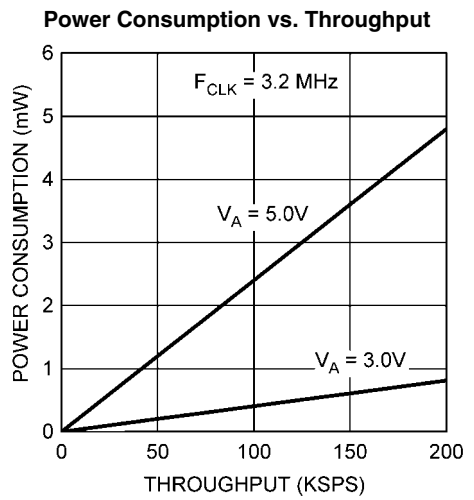
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Applications Information

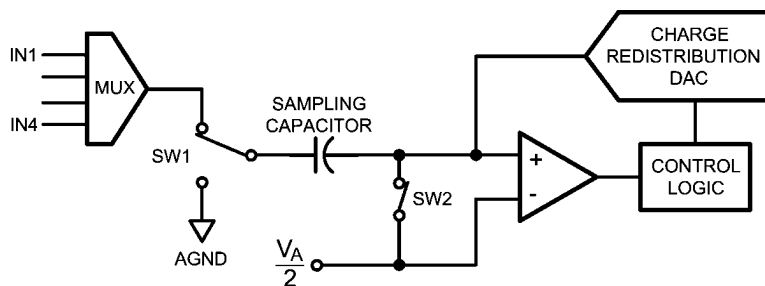
1.0 ADC084S021 OPERATION

The ADC084S021 is a successive-approximation analog-to-digital converter designed around a charge-redistribution digital-to-analog converter. Simplified schematics of the ADC084S021 in both track and hold modes are shown in and , respectively. shows the ADC084S021 in track mode: switch SW1 connects the sampling capacitor to one of four analog input channels through the multiplexer, and SW2 balances the comparator inputs. The ADC084S021 is in this state for the first three SCLK cycles after \overline{CS} is brought low.

Figure 2 shows the ADC084S021 in hold mode: switch SW1 connects the sampling capacitor to ground, maintaining the

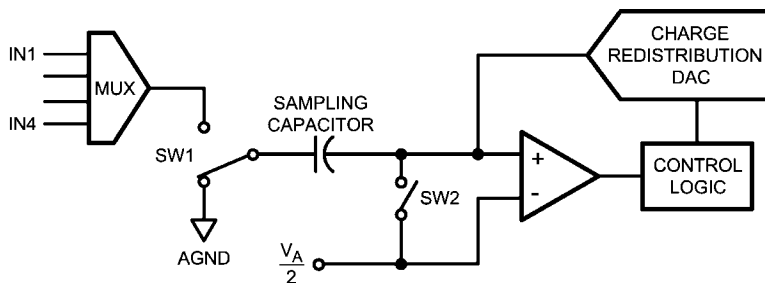
sampled voltage, and switch SW2 unbalances the comparator. The control logic then instructs the charge-redistribution DAC to add fixed amounts of charge to the sampling capacitor until the comparator is balanced. When the comparator is balanced, the digital word supplied to the DAC is the digital representation of the analog input voltage. The ADC084S021 is in this state for the fourth through sixteenth SCLK cycles after \overline{CS} is brought low.

The time when \overline{CS} is low is considered a serial frame. Each of these frames should contain an integer multiple of 16 SCLK cycles, during which time a conversion is performed and clocked out at the DOUT pin and data is clocked into the DIN pin to indicate the multiplexer address for the next conversion.



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FIGURE 1. ADC084S021 in Track Mode



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FIGURE 2. ADC084S021 in Hold Mode

2.0 USING THE ADC084S021

An ADC084S021 timing diagram and a serial interface timing diagram for the ADC084S021 are shown in the Timing Diagrams section. \overline{CS} is chip select, which initiates conversions and frames the serial data transfers. SCLK (serial clock) controls both the conversion process and the timing of serial data. DOUT is the serial data output pin, where a conversion result is sent as a serial data stream, MSB first. Data at DIN, the serial data input pin, is written to the ADC084S021's Control Register. New data is written to DIN with each conversion.

A serial frame is initiated on the falling edge of \overline{CS} and ends on the rising edge of \overline{CS} . Each frame must contain an integer multiple of 16 rising SCLK edges. The ADC output data (DOUT) is in a high impedance state when \overline{CS} is high and is active when \overline{CS} is low. \overline{CS} thus acts as an output enable, in addition to being a start conversion input. Additionally, the device goes into a power down state when \overline{CS} is high and between continuous conversion cycles.

During the first 3 cycles of SCLK, the ADC is in the track mode, acquiring the input voltage. For the next 13 SCLK cycles the conversion is accomplished and the data is clocked out, MSB first, starting with the 5th clock. If there is more than one conversion in a frame, the ADC will re-enter the track mode on the falling edge of SCLK after the $N \times 16$ th rising edge of SCLK, and re-enter the hold/convert mode at the $N \times 16 + 4$ th falling edge of SCLK, where "N" is an integer.

SCLK is internally gated off when \overline{CS} is high. If SCLK is stopped in the low state while \overline{CS} is high, the subsequent fall of \overline{CS} will generate a falling edge of the internal version of SCLK, putting the ADC into the track mode. This is seen by the ADC as the first falling edge of SCLK. If SCLK is stopped with SCLK high, the ADC enters the track mode at the first falling edge of SCLK after the falling edge of \overline{CS} .

During each conversion, data is clocked into the device at the DIN pin on the first 8 rising edges of SCLK after the fall of \overline{CS} . For each conversion, it is necessary to clock in the data indicating the input that is selected for the conversion after the

current one. That is, the conversion that is started at the fall of \overline{CS} is of the voltage at the channel that was selected when the last conversion was started. The first conversion after power up will be of the first channel. See *Tables 1, 2 and Table 3*.

If \overline{CS} and SCLK go low within the times defined by t_{CSU} and t_{CLH} , the rising edge of SCLK that begins clocking data in at DIN may be one clock cycle later than expected. It is, there-

fore, best to strictly observe the minimum t_{CSU} and t_{CLH} times given in the Timing Specifications.

There are no power-up delays or dummy conversions required with the ADC084S021. The ADC is able to sample and convert an input to full conversion immediately following power up. The first conversion result after power-up will be that of IN1.

TABLE 1. Control Register Bits

Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DONTC	DONTC	ADD2	ADD1	ADD0	DONTC	DONTC	DONTC

TABLE 2. Control Register Bit Descriptions

Bit #:	Symbol:	Description
7 - 6, 2 - 0	DONTC	Don't care. The value of these bits do not affect device operation.
5	ADD2	These three bits determine which input channel will be sampled and converted in the next track/hold cycle. The mapping between codes and channels is shown in <i>Table 3</i> .
4	ADD1	
3	ADD0	

TABLE 3. Input Channel Selection

ADD2	ADD1	ADD0	Input Channel
x	0	0	IN1 (Default)
x	0	1	IN2
x	1	0	IN3
x	1	1	IN4

3.0 ADC084S021 TRANSFER FUNCTION

The output format of the ADC084S021 is straight binary. Code transitions occur midway between successive integer LSB values. The LSB width for the ADC084S021 is $V_A/256$ and the ideal transfer characteristic is shown in . The transition from an output code of 0000 0000 to a code of 0000 0001 is at 1/2 LSB, or a voltage of $V_A/512$. Other code transitions occur at steps of one LSB.

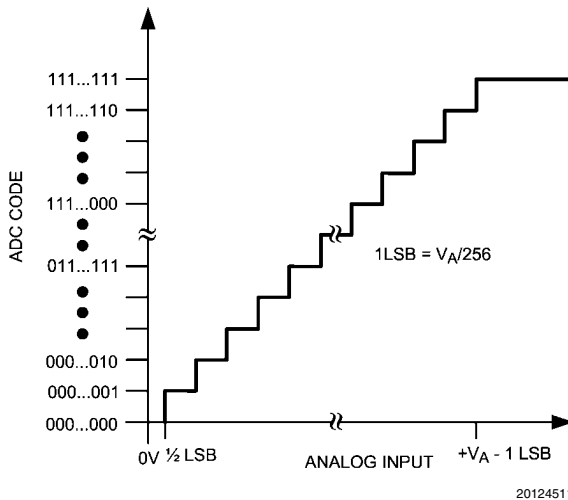
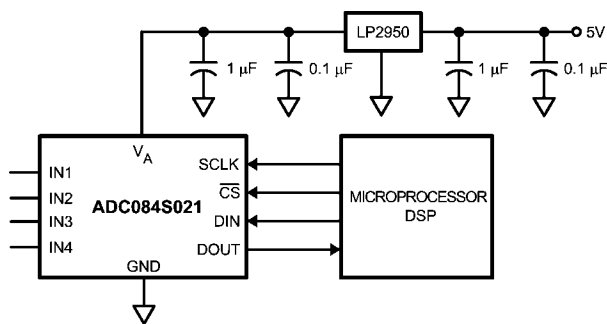


FIGURE 3. Ideal Transfer Characteristic

4.0 TYPICAL APPLICATION CIRCUIT

A typical application of the ADC084S021 is shown in *Figure 5*. Power is provided, in this example, by the National Semiconductor LP2950 low-dropout voltage regulator, available in a variety of fixed and adjustable output voltages. The power supply pin is bypassed with a capacitor network located close to the ADC084S021.

Because the reference for the ADC084S021 is the supply voltage, any noise on the supply will degrade device noise performance. To keep noise off the supply, use a dedicated linear regulator for this device, or provide sufficient decoupling from other circuitry to keep noise off the ADC084S021 supply pin. Because of the ADC084S021's low power requirements, it is also possible to use a precision reference as a power supply to maximize performance. The four-wire interface is also shown connected to a microprocessor or DSP.



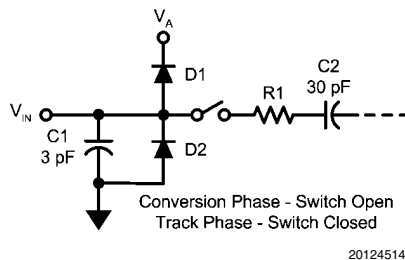
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FIGURE 4. Typical Application Circuit

5.0 ANALOG INPUTS

An equivalent circuit for one of the ADC084S021's input channels is shown in *Figure 5*. Diodes D1 and D2 provide ESD protection for the analog inputs. At no time should any input go beyond ($V_A + 300$ mV) or ($GND - 300$ mV), as these ESD diodes will begin conducting, which could result in erratic operation. For this reason, these ESD diodes should NOT be used to clamp the input signal.

The capacitor C1 in *Figure 5* has a typical value of 3 pF, and is mainly the package pin capacitance. Resistor R1 is the on resistance of the multiplexer and track / hold switch, which is typically 500 ohms. Capacitor C2 is the ADC084S021 sampling capacitor, which is typically 30 pF. The ADC084S021 will deliver best performance when driven by a low-impedance source to eliminate distortion caused by the charging of the sampling capacitance. This is especially important when using the ADC084S021 to sample AC signals. Also important when sampling dynamic signals is a band-pass or low-pass filter to reduce harmonics and noise, improving dynamic performance.



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FIGURE 5. Equivalent Input Circuit

6.0 DIGITAL INPUTS AND OUTPUTS

The ADC084S021's digital output, DOUT, is limited by and cannot exceed the supply voltage, V_A . The digital input pins are not prone to latch-up and, although not recommended, SCLK, CS and DIN may be asserted before V_A without any latchup risk.

7.0 POWER SUPPLY CONSIDERATIONS

The ADC084S021 is fully powered-up whenever \overline{CS} is low, and fully powered-down when \overline{CS} is high, with one exception: the ADC084S021 automatically enters power-down mode between the 16th falling edge of a conversion and the 1st falling edge of the subsequent conversion (see Timing Diagrams).

The ADC084S021 can perform multiple conversions back to back; each conversion requires 16 SCLK cycles. The ADC084S021 will perform conversions continuously as long as \overline{CS} is held low.

7.1 Power Management

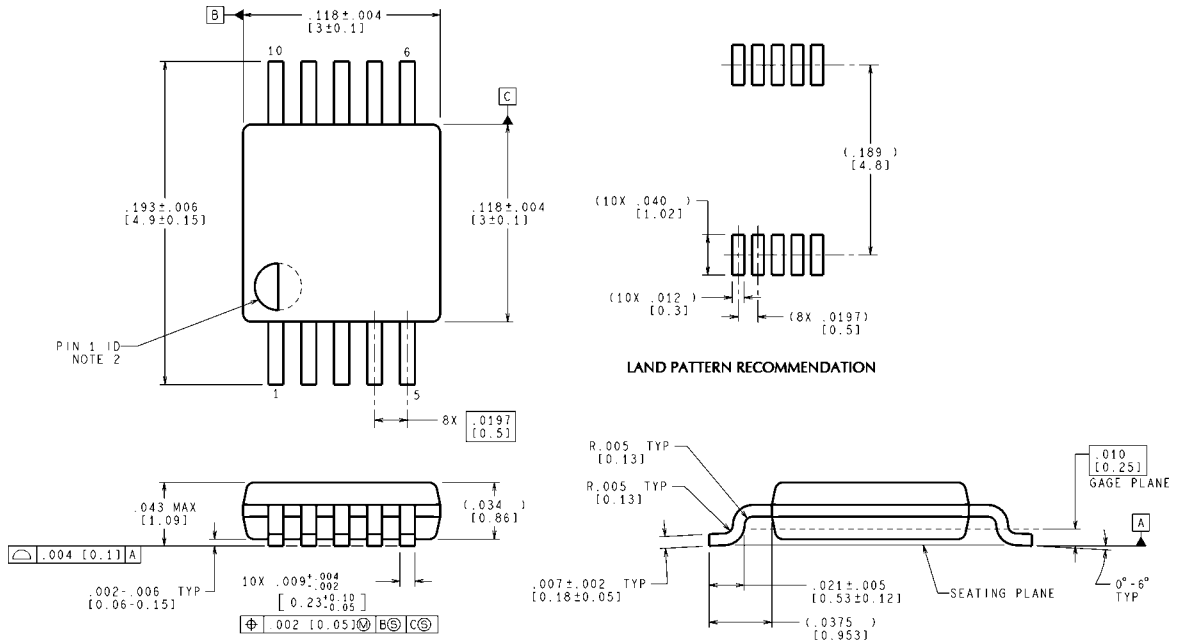
When the ADC084S021 is operated continuously in normal mode, the maximum throughput is $f_{SCLK}/16$. Performance will remain as stated in the electrical tables as long as the SCLK frequency remains within the range stated at the heading of those tables. Throughput may be traded for power consumption by running f_{SCLK} at its maximum 3.2 MHz and performing fewer conversions per unit time, putting the ADC084S021 into shutdown mode between conversions. A plot of typical power consumption versus throughput is shown in the Typical Performance Curves section. To calculate the power consumption for a given throughput, multiply the fraction of time spent in the normal mode by the normal mode power consumption and add the fraction of time spent in shutdown mode multiplied by the shutdown mode power consumption. Generally, the user will put the part into normal mode and then put the part back into shutdown mode. Note that the curve of power consumption vs. throughput is nearly linear. This is because the power consumption in the shutdown mode is so small that it can be ignored for all practical purposes.

7.2 Power Supply Noise Considerations

The charging of any output load capacitance requires current from the power supply, V_A . The current pulses required from the supply to charge the output capacitance will cause voltage variations of the supply voltage. If these variations are large enough, they could degrade SNR and SINAD performance of the ADC. Furthermore, discharging the output capacitance when the digital output goes from a logic high to a logic low will dump current into the die substrate. Load discharge currents will cause "ground bounce" noise in the substrate that will degrade noise performance if that current is large enough. The larger is the output capacitance, the more current flows through the die supply line and substrate, causing more noise to be coupled into the analog channel and degrading noise performance.

To keep noise out of the power supply, keep the output load capacitance as small as practical. If the load capacitance is greater than 50 pF, use a 100 Ω series resistor at the ADC output, located as close to the ADC output pin as practical. This will limit the charge and discharge current of the output capacitance and improve noise performance.

Physical Dimensions inches (millimeters) unless otherwise noted



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MUB10A (Rev B)

10-Lead MSOP
Order Number ADC084S021C1MM, ADC084S021C1MMX
NS Package Number P0MUB10A

Notes

Notes

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